

# TPS65950 Schematic Checklist

#### **ABSTRACT**

This application note for TPS65950, a power companion device for OMAP processors, lists the connection details for each pin. The ball details include a brief explanation of the function of each pin or signal and whether the signal is analog or digital. Use this information to check the connectivity for each ball on a system schematic.



#### Table 1. TPS65950 Schematic Checklist

Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
H4	ADC	ADCIN0		Battery type	Ю	A		Internal current source. Limited input voltage 1.5 V. No prescaler. Grounded if not used.	GND
J3		ADCIN1		Battery temperature	Ю	А		BCI battery presence check. Internal current source. Limited input voltage 1.5 V. No prescaler. Cannot be used as general-purpose. Grounded if not used.	GND
G3		ADCIN2		General-purpose ADC input	1	Α		Prescaler integrated. Limited input voltage 2.5 V. Grounded if not used.	GND
P5	Charger	vccs		Charge current sensing	1	A		Precharge battery voltage sensing. 0.22 Rs sense resistor close to device. Routing matched with VBATS. Resistance max $3\Omega$ . Connected to VRPRECH if not used.	Connected to VRPRECH if not used
N5		VAC		Charge device input voltage	POWER	A		Charger presence detection and connection. Add RC and transistor for in-rush current limitation. Grounded if BCI not used. 7-V maximum.	Connected to ground
P4		VBATS		Charge current sensing	I	А		Precharge battery voltage sensing. 0.22 Rs sense resistor close to device. Routing matched with VCCS. Resistance max $3\Omega$ . Connected to VRPRECH if not used.	Connected to VRPRECH if not used
N4		PCHGAC		Ac precharge sense signal. Also used for EEPROM.	I	A		Ac path, power FET power dissipation limitation, check TRM for calculation. Common value are in the 700K range.	GND
N6		PCHGUSB		USB precharge sense signal	I	A		USB path, power FET power dissipation limitation, check TRM for calculation. Common values are in the 500K range.	GND
N2		VPRECH		Precharge regulator output	0	Α		Capacitor of 1uF to ground. Cap to ground if BCI not used.	1uF cap to GND
N1		BCIAUTO		Linear charge specific boot mode	I	А		Resistor connected between BCIAUTO pin and GND: 22K for CVENACA = 0 or 140K for CVENACA = 1. Grounded if BCI not used.	GND
P6		ICTLUSB1		USB power device control	0	Α		Don't forget stability external component. Floating if BCI not used.	Floating
P1		ICTLUSB2		USB power device control	0	А		Don't forget stability external component. Floating if BCI not used.	Floating
N7		ICTLAC1		Ac power device control	0	А		Don't forget stability external component. Floating if BCI not used.	Floating



Table 1. TPS65950 Schematic Checklist (continued)

Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
P2		ICTLAC2		Ac power device control	0	А		Don't forget stability external component. Floating if BCI not used.	Floating
R5		VBAT		Battery voltage sensing	POWER	А		Add 10 F Filtering capacitor. VBAT level sense.	VBAT
P12	GPIOs/JTAG	GPIO0/CD 1		GPIO0/card detection 1	Ю	D		Can be left floating as internal PD	Floating
		JTAG.TDO		JTAG test data output	Ю	D		Connected to TDI next chip if used	
N12		GPIO1/CD 2		GPIO1/card detection 2	Ю	D		Can be left floating as internal PD	Floating
		JTAG.TMS		JTAG test mode state	I	D		Connected to general TMS if used.	
L4		GPIO2		GPIO2	Ю	D		Can be left floating as internal PD	Floating
		TEST1		TEST1 pin used in test mode only	Ю	D		Can be left floating as internal PD. TP.	
P13		GPIO15		GPIO15	Ю	D		Can be left floating as internal PD	Floating
		TEST2		TEST2 pin used in test mode only	Ю	D		Can be left floating as internal PD. TP.	
M4		GPIO6	PMBR1/GPI O6_CLKOK_ PWM0_MUT E/b00	GPIO6	Ю	D		Can be left floating as internal PD	Floating
			PMBR1/GPI O6_CLKOK_ PWM0_MUT E/b11	Clock OK	0	D			
		PWM0	PMBR1/GPI O6_CLKOK_ PWM0_MUT E/b01	Pulse width driver 0	0	D		Can be left floating as internal PD	
		TEST3		TEST3 pin used in test mode only (controlled by JTAG)	Ю	D		Can be left floating as internal PD. TP	
N14		GPIO7	PMBR1/GPI O7_VIBRAS YNC_PWM1/ b00	GPIO7	Ю	D		Can be left floating as internal PD	Floating



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		VIBRA.SY NC	PMBR1/GPI O7_VIBRAS YNC_PWM2/ b01	Vibrator ON-OFF synchronization	I	D		Can be left floating as internal PD or PU.	
		PWM1	PMBR1/GPI O7_VIBRAS YNC_PWM3/ b11	Pulse width driver 1	0	D	0	Can be left floating as output.	
		TEST4		TEST4 pin used in test mode only (controlled by JTAG)	Ю	D		Can be left floating as internal PD or PU. TP.	
J9	START.ADC	START.AD C		ADC conversion request	I	D		Grounded if not used	GND
C13	CONTROL	SYSEN		System enable output	Open drain/I	D	0	Control slave power IC in master mode or force T2 in Wai-on if low in slave mode. TP required.	Floating
C6		CLKEN		Clock e3nable	0	D	0	Clock enable, TP	Floating
D7		CLKEN2		Clock enable 2	0	D	0	Clock enable 2, TP	Floating
G10		CLKREQ		Clock request	I	D		NSLEEP3. Associated with processor3.TP. Grounded if not used.	GND
F10		INT1		output interrupt line	0	D	0	output interrupt for processor 1. TP.	Floating
F9		INT2		output interrupt line 2	0	D	0	output interrupt for processor 2. TP.	Floating
A13		NRESPWR ON		output control the NRESPWRON of the application processor	0	D	0	Control of host processor reset. TP.	Floating
B13		NRESWAR M		input, detect user action on the reset button.	I	D		User reset. TP. PU required if connected to button. GND if not used.	GND
A11		PWRON		input. Detect a control command to start or stop the system.	I	D		Switch on control. TP (secondary general reset after 8 slow state and battery removal). Need external PU of $5 \text{K}\Omega$ .	VBAT
B14		NC		Not connected					
P7		NSLEEP1		Sleep request from device 1	I	D		Sleep request from processor 1. TP.	GND

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G9		NSLEEP2		SLEEP request from device 2	I	D		Sleep request from processor 2. TP. Grounded if not used.	GND
D13		CLK256FS			0	D	0	Audio clock 256 FS. TP.	Floating
F8		VMODE1		Digital voltage scaling linked with VDD1	I	D		Digital voltage scaling. Ground if not used.	GND
K11		воото		Boot pin 0 <sup>(1)</sup>	IO	A/D		Boot selection. TP. 4 possibilities.	
J11		BOOT1		Boot pin 1 <sup>(1)</sup>	IO	A/D		Boot selection. TP. 4 possibilities.	
A10		REGEN		Enable signal for external LDO	Open drain	D	0	External LDO control. TP.	Floating
H8		MSECURE		Security and digital rights management	I	D		Secure mode: 1 to be active (RW of secure registers possible). Unsecure mode: 0. Only read is possible.	
N16	VREF	VREF		Reference voltage	POWER	А		Bandgap voltage. 1 uF cap between VREF and AGND.	
N15		AGND		Analog ground for reference voltage	POWER GND	А		Clean analog ground connected to 1 plane	
C4	I <sup>2</sup> C SmartReflex™	I2C.SR.SD A		SmartReflex I <sup>2</sup> C data	Ю	D		Floating if not used	Floating
D6		VMODE2		Digital voltage scaling linked with VDD2	1	D		Digital voltage scaling. GND If not used.	GND
		I2C.SR.SC L		SmartReflex I <sup>2</sup> C data	Ю	D		GND if not used.	
D4	I <sup>2</sup> C	I2C.CNTL. SDA		General-purpose I <sup>2</sup> C data	Ю	D			
D5		I2C.CNTL. SCL		General-purpose I <sup>2</sup> C clock	I	D			
R1	PCM	PCM.VCK		Data clock (voice port)	Ю	D		All voice PCM signals must be routed symetrically. TP.	Floating
T2		PCM.VDR		Data receive (voice port)	Ю	D		All voice PCM signals must be routed symetrically. TP. Grounded if not used.	GND
T15		PCM.VDX		Data transmit (voice port)	Ю	D		All voice PCM signals must be routed symetrically. TP.	Floating
R16		PCM.VFS		Frame synchro (voice port)	Ю	D		All voice PCM signals must be routed symetrically. TP.	Floating

Output is used for PM bus to output data (for test).



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L3	TDM	I2S.CLK		Clock signal (audio port)	Ю	D		All audio I2S signals must be routed symetrically. TP.	Floating
K6		I2S.SYNC		Synchronization signal (audio port)	Ю	D		All audio I2S signals must be routed symetrically. TP.	Floating
K4		I2S.DIN		Data receive (audio port)	I	D		All audio I2S signals must be routed symetrically. TP. Grounded if not used.	GND
K3		I2S.DOUT		Data transmit (audio port)	0	D		All audio I2S signals must be routed symetrically. TP.	Floating
E2	ANA.MIC	MIC.MAIN. P		Main microphone left input (P)	I	A		Route symmetrically with MIC.MAIN.M, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
F2		MIC.MAIN. M		Main microphone left input (M)	I	А		Route symmetrically with MIC.MAIN.P, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
G2		MIC.SUB.P		Main microphone right input (P)	I	A		Route symmetrically with MIC.SUB.M, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
		DIG.MIC.0		Digital microphone 0 input data	I	А		Digital microphone input. TP. Cap to ground if not used.	
H2		MIC.SUB.M		Main microphone right input (M)	I	A		Route symmetrically with MIC.SUB.P, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
		DIG.MIC.1		Digital microphone 1 input data	1	А		Digital microphone input. TP. Cap to ground if not used.	
E3	Headset microphone	HSMIC.P		Headset microphone input (P)	I	A		Route symmetrically with HSMIC.M, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
F3		HSMIC.M		Headset microphone input (M)	I	A		Route symmetrically with HSMIC.P, shielded, with TDMA filtering cap and coupling capacitor. Cap to ground if not used.	Floating
D10	Hands-free	VBAT.LEF T		Battery voltage input	POWER	А		Filtering capacitor of 1 uF. Connected to VBAT if not used.	VBAT
D9		VBAT.LEF T		Battery voltage input	POWER	А		Filtering capacitor of 1 uF. Connected to VBAT if not used.	VBAT

Table 1. TPS65950 Schematic Checklist (continued)

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В9		IHF.LEFT.P		Hands-free left speaker output (P)	0	A		Serial Ferrite cheap bead (high impedance at high frequency and low impedance at low frequency) or inductor + filtering 1 nF cap	Floating
B10		IHF.LEFT. M		Hands-free left speaker output (M)	0	А		Serial Ferrite cheap bead (high impedance at high frequency and low impedance at low frequency) or inductor + filtering 1 nF cap	Floating
C10		GND.LEFT		GND	POWER GND	А		Ground connected to 1 plane	GND
C9		GND.LEFT		GND	POWER GND	А		Ground connected to 1 plane	GND
D12		VBAT.RIG HT		Battery voltage input	POWER	А		Filtering capacitor of 1 uF. Connected to VBAT if not used.	VBAT
D11		VBAT.RIG HT		Battery voltage input	POWER	А		Filtering capacitor of 1 uF. Connected to VBAT if not used.	VBAT
B11		IHF.RIGHT.		Hands-free right speaker output (P)	0	A		Serial Ferrite cheap bead (high impedance at high frequency and low impedance at low frequency) or inductor + filtering 1 nF cap	Floating
B12		IHF.RIGHT.		Hands-free right speaker output (M)	0	A		Serial Ferrite cheap bead (high impedance at high frequency and low impedance at low frequency) or inductor + filtering 1 nF cap	Floating
C12		GND.RIGH T		GND	POWER GND	А		Ground connected to 1 plane	GND
C11		GND.RIGH T		GND	POWER GND	А		Ground connected to 1 plane	GND
A6	Earpiece	EAR.P		Earpiece output differential output (P)	0	A		Route symetrically to EAR.M and add TDMA filtering cap	Floating
A7		EAR.M		Earpiece output differential output (M)	0	A		Route symetrically to EAR.P and add TDMA filtering cap	Floating
B4	Headset	HSOL		Differential/single- ended headset left output	0	A		Add decoupling 22 uF cap and add TDMA filtering cap. For anti-pop system, external FET need driven by GPIO6.	Floating
B7		PreDriv.LE FT		Predriver output left P for external class-D amplifier	0	A		Audio output to connect external device through coupling capacitor of at least 1 uF	Floating
		VMID			POWER	A		Headset output common mode voltage for specific applicative case without coupling cap. Controlled by Predriv.LEFT register.	



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B5		HSOR		Differential/single- ended headset right output (P)	0	A		Add decoupling 22 uF cap and add TDMA filtering cap. For anti-pop system, external FET must be driven by GPIO6.	Floating
B8		PreDriv.RI GHT		Predriver output right P for external class-D amplifier	0	А		Audio output to connect external device through coupling capacitor of at least 1 uF	GND
		ADCIN7		General-purpose ADC input 7	1	А		General-purpose. Prescaler integrated. Limited input voltage 2.5 V. Grounded if not used.	
F1	AUX input	AUXL		Auxiliary audio input left	I	A		Add TDMA filtering capacitor and 100 nF coupling cap. Cap to ground if not used.	Floating
G1		AUXR		Auxiliary audio input right	I	A		Add TDMA filtering capacitor and 100 nF coupling cap. Cap to ground if not used.	Floating
D1	VMIC BIAS	MICBIAS1. OUT		Analog microphone bias 1	POWER	A		Serial resistor required for filtering cap higher than 200 pF	Floating
		VMIC1.OU T		Digital microphone power supply 1	POWER	A		Digital microphone biasing. Add filtering capacitor.	
D2		MICBIAS2. OUT		Analog microphone bias 2	POWER	A		Serial resistor required for filtering cap higher than 200 pF	Floating
		VMIC2.OU T		Digital microphone power supply 2	POWER	A		Digital microphone biasing. Add filtering capacitor.	
E4		VHSMIC.O UT		Headset microphone bias	POWER	A		HS microphone biasing through serial resistor	Floating
D3		MICBIAS.G ND		Dedicated ground for microphones	POWER GND			Connected to AGND	GND
J4/J6/J7/ J8/E5		AVSS1		Analog ground	POWER GND	A		Analog ground connected to 1 plane	
R10		AVSS2		Analog ground	POWER GND	A		Analog ground connected to 1 plane	
M 15		AVSS3		Analog ground	POWER GND	A		Analog ground connected to 1 plane	
C7		AVSS4		Analog ground	POWER GND	А		Analog ground connected to 1 plane	
B1	Headset UART	UART1.TX D		Headset UART transmit data	Open drain	D		External PU can be required to 1.8 or 3.3 V. Floating if not used.	Floating
D8		GPIO8		GPIO8	I	D		Floating if not used	Floating

Table 1. TPS65950 Schematic Checklist (continued)

Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
		UART1.RX D	MCPC_CTRL /HS_UART= 0b1	Headset UART receive data/switch detection	I	D		Floating if not used	
N11	MCPC	RTSO/CLK 64K.OUT/B ERCLK.OU T	A_CTRL/SEL	Ready to send output/64-kHz output clock/BER clock out in test mode	OD	D		External PU can be required to 1.8 or 3.3 V. Serial resistance between 22 and 100 $\Omega$ + diode.	Floating
		ADCIN5	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b1	Genera-purpose ADC input 5	I	A		General-purpose. Prescaler integrated. Limited input voltage 2.5 V. Grounded if not used.	
P11		CTSI/BER DATA.OUT	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b0	Clear to send input/BERDATAOU T in test mode	OD/CMOS/IO	D		External PU can be required to 1.8 or 3.3 V. Serial 50 $\Omega$ RRTSO resistor.	GND
		ADCIN3	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b1	General-purpose ADC input 3	I	A		General-purpose. Prescaler integrated. Limited input voltage 2.5 V. Grounded if not used.	
N8		TXAF	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b0		I	A		Add 100 nF coupling capacitor to ground if not used.	GND
		ADCIN4	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b1	General-purpose ADC input 4	I	A		General-purpose. Prescaler integrated. Limited input voltage 2.5 V.dd 100 nF coupling capacitor to ground if not used.	
N9		RXAF	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b0		0	A		Add 1 uF coupling capacitor. Floating if not used.	Floating
		ADCIN6	CARKIT_AN A_CTRL/SEL _MADC_MC PC=b1	General-purpose ADC input 6	I	A		General-purpose. Prescaler integrated. Limited input voltage 2.5 V. Floating if not used.	
L10		MANU		Manufacturer pin	1	D		Floating if not required	Floating
N10	CLOCK	32KCLKOU T		Buffered output of the 32-kHz digital clock	0	D		No more than 40-pF load programmable	Floating



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P16		32KXIN		Input of the 32-kHz oscillator	1	A		External capacitor to AGND to add. Value of this cap plus 5 pF internal must equal oscillator cap specification, symetrically to 32KXOUT.	
P15		32KXOUT		Output of the 32-kHz oscillator	0	A		External capacitor to AGND to add. Value of this cap plus 5 pF internal must equal oscillator cap specification, symetrically to 32KXIN.	Floating
A14		HFCLKIN		Input of the digital (or sine) high-speed clock	I	A		For sine wave, no more than 1.45 Vpp amplitude	
R12		HFCLKOU T		High-speed clock output	0	D		No more than 40-pF load programmable	Floating
R8	USB PHY	VBUS		VBUS power rail	POWER	A		Directly connected to USB connector without resistive add. 4.7 uF cap connected between VBUS and VSSP.	GND
T10		DP/UART3. RXD		USB data P/USB carkit receive data/UART3 receive data	Ю	A		Directly connected to USB symetrically with TXD	Floating
T11		DN/UART3. TXD		USB data N/USB Carkit transmit data/UART3 transmit data	Ю	A		Directly connected to USB symetrically with RXD	Floating
R11		ID		USB ID	Ю	Α		Connected to VUSB3P1 if not used	Connected to VUSB3P1
L15	ULPI	UCLK		High-speed USB clock	Ю	D		Connected to OMAP. Floating if not used.	Floating
L14		STP	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB stop	I	D		Connected to OMAP. Floating if not used.	Floating
		GPIO9		GPIO9	Ю	D			
L13		DIR		High-speed USB direction	0	D		Connected to OMAP. Floating if not used.	Floating
		GPIO10		GPIO10	Ю	D			
M13		NXT	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB next	0	D		Connected to OMAP. Floating if not used.	Floating

Table 1. TPS65950 Schematic Checklist (continued)

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		GPIO11		GPIO11	Ю	D			
K14		DATA0	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0, MCPC_CTRL /RTSCTSSW = b0	High-speed USB data0	Ю	D		Connected to OMAP. Floating if not used.	Floating
		UART4.TX D	IFC_CTRL/F SLSSERIAL MODE_3PIN = b1, MCPC_CTRL /RTSCTSSW = b1	UART4.TXD	I	D		Connected to OMAP. Floating if not used.	
K13		DATA1	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0, MCPC_CTRL /RTSCTSSW = b0	High-speed USB data1	Ю	D		Connected to OMAP. Floating if not used.	Floating
		UART4.RX D	IFC_CTRL/F SLSSERIAL MODE_3PIN = b1, MCPC_CTRL /RTSCTSSW = b1	UART4.RXD	0	D		Connected to OMAP. Floating if not used.	
J14		DATA2	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0, MCPC_CTRL /RTSCTSSW = b0	High-speed USB data2	Ю	D		Connected to OMAP. Floating if not used.	Floating
		UART4.RT SI	IFC_CTRL/F SLSSERIAL MODE_3PIN = b1, MCPC_CTRL /RTSCTSSW = b1	UART4.RTSI	1	D		Connected to OMAP. Floating if not used.	



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J13		DATA3	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0, MCPC_CTRL /RTSCTSSW = b0	High-speed USB data3	Ю	D		Connected to OMAP. Floating if not used.	Floating
		UART4.CT SO	IFC_CTRL/F SLSSERIAL MODE_3PIN = b1, MCPC_CTRL /RTSCTSSW = b1	UART4.CTSO	0	D		Connected to OMAP. Floating if not used.	
		GPIO12		GPIO12	IO	D			
G14		DATA4	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB data4	Ю	D		Connected to OMAP. Floating if not used.	Floating
		GPIO14		GPIO14	IO	D			
G13		DATA5	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB data5	Ю	D		Connected to OMAP. Floating if not used.	Floating
		GPIO3		GPIO3	IO	D			
F14		DATA6	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB data6	Ю	D		Connected to OMAP. Floating if not used.	Floating
		GPIO4		GPIO4	Ю	D			
F13		DATA7	IFC_CTRL/F SLSSERIAL MODE_3PIN = b0	High-speed USB data7	Ю	D		Connected to OMAP. Floating if not used.	Floating
		GPIO5		GPIO5	Ю	D			
T16	TEST	TEST.RES ET		Reset T2 device (except power state-machine)	1	A/D		PD, cannot be used for application !	GND
T1		TESTV1		Analog test	Ю	А		TP or floating if not used	Floating
A16		TESTV2		Analog test	IO	Α		TP or floating if not used	Floating

Table 1. TPS65950 Schematic Checklist (continued)

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A1		TEST		Selection between JTAG mode and application mode for JTAG/GPIOs (with PU or PD)	I	D		Connected to VIO for JTAG use or floating as internal PD if JTAG not used	Floating
A15		JTAG.TDI/ BERDATA		JTAG.TDI/BERDA TA	I	D		Grounded if not used	GND
B16		JTAG.TCK/ BERCLK		JTAG.TCK/BERCL K	I	D		Grounded if not used	GND
R7	USB CP	CP.IN		Charge pump input voltage	POWER	Α		Cap of 10 uF. Cap must be as close as possible to device.	VBAT
T7		CP.CAPP		Charge pump flying capacitor P	0	Α		Connected to CP.CAPM by a cap of 2.2 uF	Floating
T6		CP.CAPM		Charge pump flying capacitor M	0	Α		Connected to CP.CAPP by a cap of 2.2 uF	Floating
R6		CP.GND		Charge pump ground	POWER GND	Α		Connected to ground	GND
R9	VBAT.USB	VBAT.USB		USB LDOs (VINTUSB1P5, VINTUSB1P8, VUSB.3P1) VBAT	POWER	А		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
P9	USB LDO	VUSB.3P1		USB LDO output	POWER	Α		Cap of 1 uF. Do not use externally.	
L1	VAUX1	VAUX12S.I N		VAUX1/VAUX2/VSI M LDO input voltage	POWER	A		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
M2		VAUX1.OU T		VAUX1 LDO output voltage	POWER	А		Cap of 1 uF	Floating
M3	VAUX2	VAUX2.OU T		VAUX2 LDO output voltage	POWER	А		Cap of 1 uF	Floating
H15	VPLLA3R	VPLLA3R.I N		Input for VPLL1, VPLL2, VAUX3, VRTC LDOs	POWER	A		Cap of 1 uF. Important to get separate filtering.Cap must be as close as possible to device.	VBAT
K16	VRTC	VRTC.OUT		VRTC internal LDO output (internal use only)	POWER	А		Cap of 1 uF. Do not use externally.	
H14	VPLL1	VPLL1.OU T		LDO output voltage	POWER	А		Cap of 1 uF	Floating
J15	VPLL2	VSDI.CSI. OUT		oRegulator output voltage	POWER	А		Cap of 1 uF	Floating



Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
G16	VAUX3	VAUX3.OU T		VAUX3 LDO output voltage	POWER	Α		Cap of 1 uF	Floating
B2	VAUX4	VAUX4.IN		VAUX4 LDO input voltage	POWER	А		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
В3		VAUX4.OU T		VAUX4 LDO output voltage	POWER	А		Cap of 1 uF	Floating
C1	VMMC1	VMMC1.IN		VMMC1 LDO input voltage	POWER	А		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
C2		VMMC1.O UT		VMMC1 LDO output voltage	POWER	А		Cap of 1 uF	Floating
A3	VMMC2	VMMC2.IN		VMMC2 LDO input voltage	POWER	Α		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
A4		VMMC2.O UT		VMMC2 LDO output voltage	POWER	Α		Cap of 1 uF	Floating
K2	VSIM	VSIM.OUT		VSIM LDO output voltage	POWER	А		Cap of 1 uF	Floating
P8	VINTUSB1P5	VINTUSB1 P5.OUT		VINTUSB1P5 internal LDO output (Internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	Floating
P10	VINTUSB1P8	VINTUSB1 P8.OUT		VINTUSB1P8 internal LDO output (Internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	Floating
K1	Video DAC	VDAC.IN		Input for VDAC, VINTANA1, and VINTANA2 LDOs	POWER	A		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
L2		VDAC.OUT		Regulator output voltage	POWER	Α		Cap of 1 uF	Floating
K15	VINT	VINT.IN		Input for VINTDIG LDO	POWER	Α		Cap of 1 uF. Cap must be as close as possible to device.	VBAT
НЗ	VINTANA1	VINTANA1. OUT		VINTANA1 internal LDO output (internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	
J2	VINTANA2	VINTANA2. OUT		VINTANA2 internal LDO output (internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	
B6		VINTANA2. OUT		VINTANA2 internal LDO output (internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	

Table 1. TPS65950 Schematic Checklist (continued)

Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
L16	VINTDIG	VINTDIG.O UT		VINTDIG internal LDO output (internal use only)	POWER	A		Cap of 1 uF. Do not use externally.	
E15	VDD1	VDD1.IN		VDD1 DCDC input voltage	POWER	А		Cap of 10 uF. Cap must be as close as possible to device.	VBAT
E14		VDD1.IN		VDD1 DCDC input voltage	POWER	Α			VBAT
D14		VDD1.IN		VDD1 DCDC input voltage	POWER	Α			VBAT
D16		VDD1.SW		VDD1 DCDC switch	0	Α		L= 1uH to the device pad and C = 10 uF on the other end of inductor.	Floating
D15		VDD1.SW		VDD1 DCDC switch	0	Α			
C14		VDD1.SW		VDD1 DCDC switch	0	Α			
E13		VDD1.FB		VDD1 DCDC output voltage (feedback)	I	A		Connect to the LC circuit (capacitor end).	GND
C16		VDD1.GND		VDD1 DCDC ground	POWER GND	А		Connected to ground	GND
C15		VDD1.GND		VDD1 DCDC ground	POWER GND	Α		Connected to ground	GND
B15		VDD1.GND		VDD1 DCDC ground	POWER GND	Α		Connected to ground	GND
R13	VDD2	VDD2.IN		VDD2 DCDC input voltage	POWER	Α		Cap of 10 uF. Cap must be as close as possible to device.	VBAT
P14		VDD2.IN		VDD2 DCDC input voltage	POWER	Α			VBAT
N13		VDD2.FB		VDD2 DCDC output voltage (feedback)	I	A		Connect to the LC circuit (capacitor end).	GND
T13		VDD2.SW		VDD2 DCDC switch	0	А		L= 1uH to the device pad and C = 10 uF on the other end of inductor.	Floating
R14		VDD2.SW		VDD2 DCDC switch	0	Α			
T14		VDD2.GND		VDD2 DCDC ground	POWER GND	Α		Connected to ground	GND



Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
R15		VDD2.GND		VDD2 DCDC ground	POWER GND	А		Connected to ground	GND
P3	VIO	VIO.IN		VIO DCDC input voltage	POWER	A		Cap of 10 uF. Cap must be as close as possible to device.	VBAT
R4		VIO.IN		VIO DCDC input voltage	POWER	Α			VBAT
N3		VIO.FB		VIO DCDC output voltage (feedback)	I	Α		Connect to the LC circuit (capacitor end).	GND
R3		VIO.SW		VIO DCDC switch	0	Α		L= 1uH to the device pad and C = 10 uF on the other end of inductor	Floating
T4		VIO.SW		VIO DCDC switch	0	Α			
R2		VIO.GND		VIO DCDC ground	POWER GND	A		Connected to ground	GND
T3		VIO.GND		VIO DCDC ground	POWER GND	А		Connected to ground	GND
M14	Backup BAT	BKBAT		Backup battery	POWER	A		2.5- to 3.2-V backup battery. Grounded if not used.	GND
C8	Digital VDD	IO.1P8		TPS65950 I/O input	POWER	А		To connect to VIO. Add filtering cap.	
H13/H9/H 10/H11	Digital ground	DGND		Digital ground	POWER GND	А		Connected to ground	GND
F16	LED driver	LEDGND		LED driver ground	POWER GND	A		Connected to ground	GND
G11		GPIO13		GPIO13	Ю	D		Can be left floating if not used	Floating
		LEDSYNC		LED synchronization input	I	D		TP. Can be left floating if not used.	
F15		LEDA		LED leg A	Open drain	Α		Do not connect to LEDB. 2.5 times LED drive.	Floating
		VIBRA.P		H-bridge vibrator P	Open drain	А		Connected differentially with VIBRA.M. Floating if not used.	
G15		LEDB		LED leg B	Open drain	А		Do not connect to LEDA.	Floating
		VIBRA.M		H-bridge vibrator M	Open drain	А		Connected differentially with VIBRA.P. Floating if not used.	
G8	Keypad	KPD.C0		Keypad column 0	Open drain	D		Floating if not used	Floating
H7		KPD.C1		Keypad column 1	Open drain	D		Floating if not used	Floating
G6		KPD.C2		Keypad column 2	Open drain	D		Floating if not used	Floating



Table 1. TPS65950 Schematic Checklist (continued)

Ball Name	TPS65950 Pinlist	Default Configurat ion	SW Pin Muxing (Reg Name/Bit Name/Value)	Description	Туре	A/D	Output Default Value	Recommended Connectivity	Connectivity When Function is not Used
F7		KPD.C3		Keypad column 3	Open drain	D		Floating if not used	Floating
G7		KPD.C4		Keypad column 4	Open drain	D		Floating if not used	Floating
F4		KPD.C5		Keypad column 5	Open drain	D		Floating if not used	Floating
H6		KPD.C6		Keypad column 6	Open drain	D		Floating if not used	Floating
G4		KPD.C7		Keypad column 7	Open drain	D		Floating if not used	Floating
K9		KPD.R0		Keypad row 0	I	D		Floating if not used	Floating
K8		KPD.R1		Keypad row 1	1	D		Floating if not used	Floating
L8		KPD.R2		Keypad row 2	1	D		Floating if not used	Floating
K7		KPD.R3		Keypad row 3	1	D		Floating if not used	Floating
L9		KPD.R4		Keypad row 4	I	D		Floating if not used	Floating
J10		KPD.R5		Keypad row 5	I	D		Floating if not used	Floating
K10		KPD.R6		Keypad row 6	1	D		Floating if not used	Floating
L7		KPD.R7		Keypad row 7	I	D		Floating if not used	Floating
C3	Bluetooth <sup>™</sup> (BT)	GPIO16		GPIO16	Ю	D		Floating if not used	Floating
		BT.PCM.V DR		Bluetooth PCM receive data	Ю	D		All BT PCM signals must be routed symetrically. TP.	
		DIG.MIC.C LK0		Digital microphone clock 0	0	D		Can be left floating if not used	
C5	GPIO17	GPIO17		GPIO17	Ю	D		Floating if not used	Floating
		BT.PCM.V DX		BT PCM transmit data	Ю	D		All BT PCM signals must be routed symetrically. TP.	
		DIG.MIC.C LK1		Digital microphone clock 1	0	D		Can be left floating if not used	
A2	RFID	RFID.EN		Enable for the RFID device	0	D	0	Can be left floating if not used	Floating

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